

February 2010

FFB20UP20DN_F085 10A, 200V Ultrafast Dual Rectifiers

Features

- High Reverse Voltage : V_{RRM} = 200V
- Avalanche Energy Rated
- Planar Construction

Applications

- Output Rectifiers
- Switching Mode Power Supply
- Free-wheeling diode for motor application
- Power switching circuits
- Qualified to AEC Q101
- RoHS Compliant

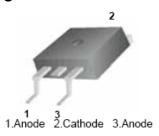
Description

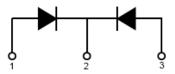
The FFB20UP20DN_F085 is an ultrafast rectifier. It has a low forward voltage drop and is a silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and hyperfast recovery minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.



Pin Assignments





Anode 2. Cathode 3. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{RRM}	Peak Repetitive Reverse Voltage	200	V	
V_{RWM}	Working Peak Reverse Voltage	200	V	
V _R	DC Blocking Voltage	200	V	
I _{f(avg)}	Average Rectified Forward Current @ T _C =	155°C 10	А	
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	100	Α	
T _J , T _{STG}	Operating Junction and Storage Temperature	-55 to +175	°C	

Thermal Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Max	Units
$R_{\theta JC}^{1}$	Maximum Thermal Resistance, Junction to Case	3.5	°C/W

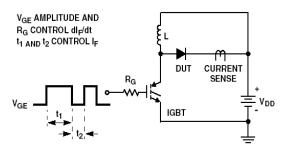
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F20UP20DN	FFB20UP20DN_F085	TO-263	13"	24mm	800

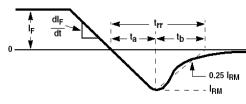
Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max	Units
V _F ²	I _F = 10A I _F = 10A	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 150^{\rm o}{\rm C}$	-	-	1.15 1.0	V V
I _R ²	V _R = 200V V _R = 200V	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 150^{\rm o}{\rm C}$	-	- -	10 250	μ Α μ Α
t _{rr}	I_F =1A, di/dt = 200A/ μ s, V_{CC} = 130V I_F =10A, di/dt = 200A/ μ s, V_{CC} = 130V	$T_C = 25$ °C $T_C = 25$ °C	-	15 27	25 40	ns ns
t _a t _b Q _{rr}	$I_F = 10A$, di/dt = 200A/ μ s, $V_{CC} = 130V$	$T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$	- - -	21 6 50	- - -	ns ns nC
W _{AVL}	Avalanche Energy (L = 20mH)	•	10	-	-	mJ

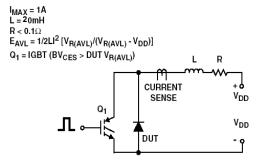
- Notes
 1: Rth_jc value is specified for each die
 2: Pulse: Test Pulse width = 300S, Duty Cycle = 2%



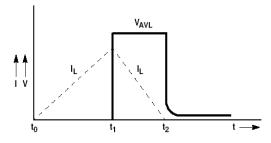




t_{rr} WAVEFORMS AND DEFINITIONS







AVALANCHE CURRENT AND VOLTAGE WAVEFORMS



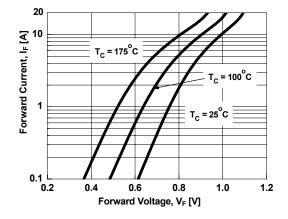


Figure 1. Typical Forward Voltage Drop

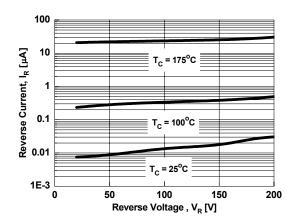


Figure 2. Typical Reverse Current

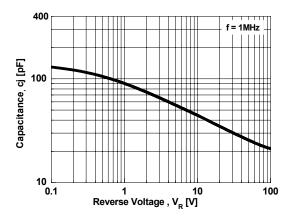


Figure 3. Typical Junction Capacitance

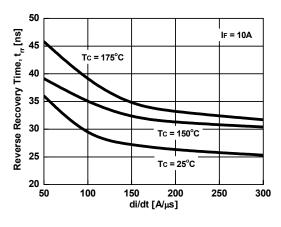


Figure 4. Typical Reverse Recovery Time

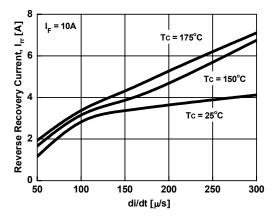


Figure 5. Typical Reverse Recovery Current

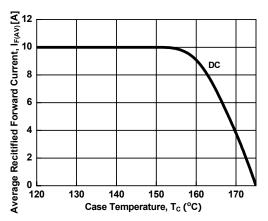
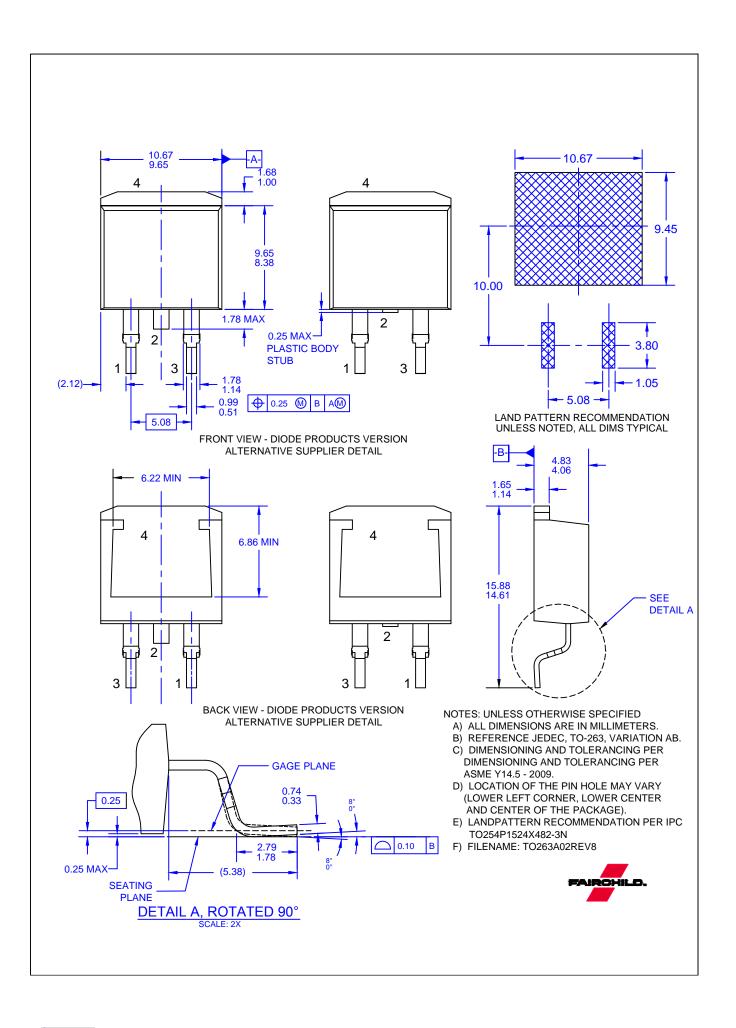


Figure 6. Case Temperature, T_c [°C]



ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

Phone: 421 33 790 2910 **Japan Customer Focus Center**Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative